NCE N-Channel Enhancement Mode Power MOSFET

DESCRIPTION

The NCE01H14 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

GENERAL FEATURES

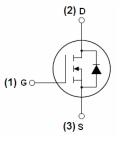
- V_{DS} =100V, I_{D} =140A $R_{DS(ON)}$ < 6.5mΩ @ V_{GS} =10V (Typ:4.5mΩ)
- High density cell design for ultra low Rdson
- Fully characterized Avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation
- Special process technology for high ESD capability

Application

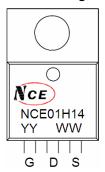
- Power switching application
- Hard Switched and High Frequency Circuits
- Uninterruptible Power Supply

100% UIS TESTED!

100% ΔVds TESTED!



Schematic diagram



Marking and pin Assignment



TO-220 top view

Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE01H14	NCE01H14	TO-220	-	-	-

Absolute Maximum Ratings (TA=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	140	Α
Drain Current-Continuous(T _C =100℃)	I _D (100℃)	97	Α
Pulsed Drain Current	I _{DM}	550	Α
Maximum Power Dissipation	P _D	330	W
Derating factor		2.2	W/℃
Single pulse avalanche energy (Note 5)	E _{AS}	1200	mJ
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 175	$^{\circ}$

NCE01H14

Thermal Characteristic

Thermal Resistance, Junction-to-Case(Note 2)	$R_{ heta JC}$	0.45	°C/W	
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Electrical Characteristics (TA=25°C unless otherwise noted)

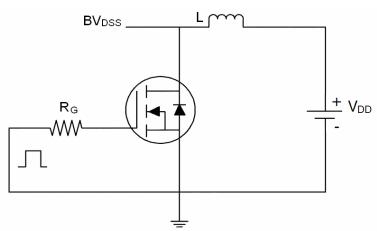
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics	•					•
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	100			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V			1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2	3	4	V
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =40A		4.5	6.5	mΩ
Forward Transconductance	g FS	V _{DS} =50V,I _D =40A	170			S
Dynamic Characteristics (Note4)			•			
Input Capacitance	C _{lss}	.,,,		7650		PF
Output Capacitance	C _{oss}	V_{DS} =50V, V_{GS} =0V,		540		PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz		250		PF
Switching Characteristics (Note 4)	•					•
Turn-on Delay Time	t _{d(on)}			25		nS
Turn-on Rise Time	t _r	V _{DD} =65V,I _D =40A		100		nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10V, R_{GEN} =2.5 Ω		65		nS
Turn-Off Fall Time	t _f	-		77		nS
Total Gate Charge	Qg	\/ 44\/ 40A		120		nC
Gate-Source Charge	Q _{gs}	$V_{DS}=44V,I_{D}=40A,$		30		nC
Gate-Drain Charge	Q_{gd}	- V _{GS} =10V		35		nC
Drain-Source Diode Characteristics	•					•
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =40A		0.85	1.2	V
Diode Forward Current (Note 2)	Is				40	Α
Reverse Recovery Time	t _{rr}			45	70	nS
Reverse Recovery Charge	Qrr			80	120	nC
Forward Turn-On Time	t _{on}	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)			y LS+LD)	

Notes:

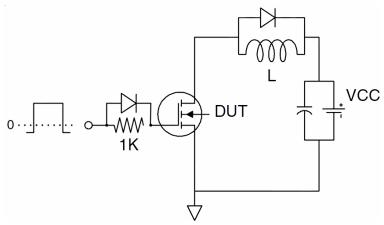
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- 3. Pulse Test: Pulse Width ≤ 300µs, Duty Cycle ≤ 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition: Tj=25 $^{\circ}\text{C}\text{,V}_{DD}\text{=}50\text{V}\text{,V}_{G}\text{=}10\text{V}\text{,L=}1\text{mH,Rg=}25\Omega$

Test circuit

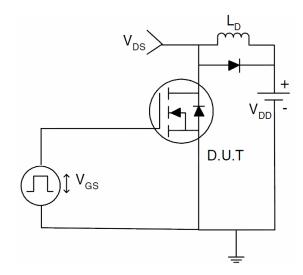
1) E_{AS} test Circuits



2) Gate charge test Circuit:



3) Switch Time Test Circuit:



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (Curves)

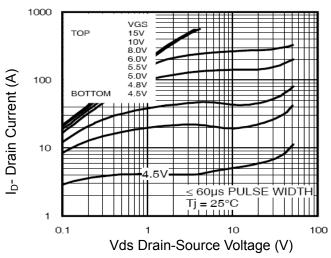


Figure 1 Output Characteristics

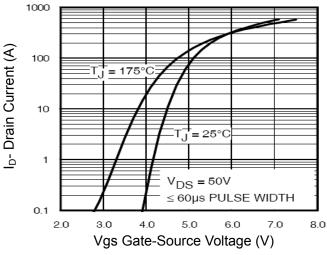


Figure 2 Transfer Characteristics

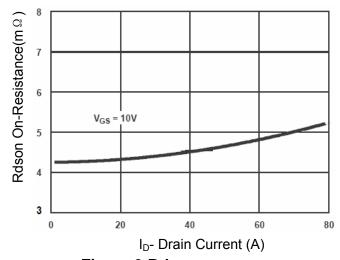


Figure 3 Rdson- Drain Current

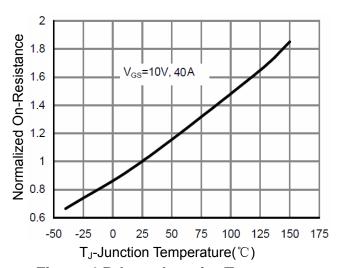


Figure 4 Rdson-JunctionTemperature

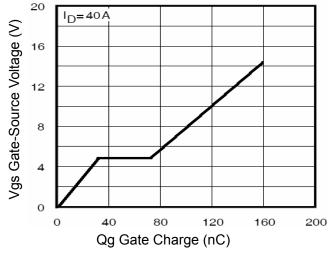


Figure 5 Gate Charge

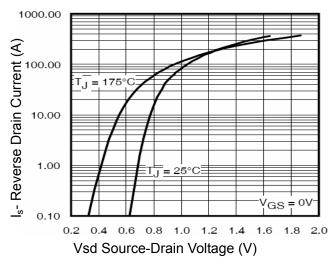


Figure 6 Source- Drain Diode Forward

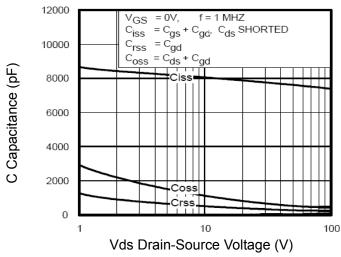


Figure 7 Capacitance vs Vds

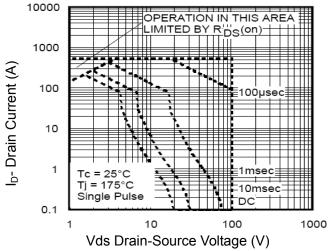


Figure 8 Safe Operation Area

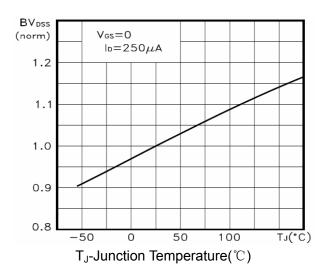


Figure 9 BV_{DSS} vs Junction Temperature

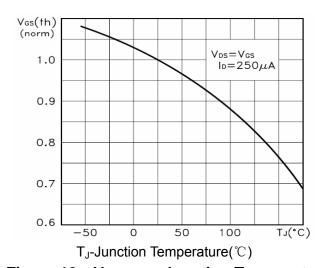


Figure 10 V_{GS(th)} vs Junction Temperatur

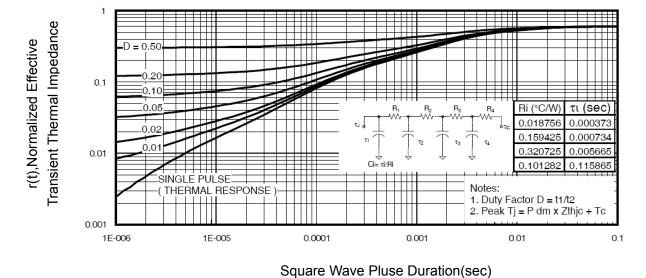
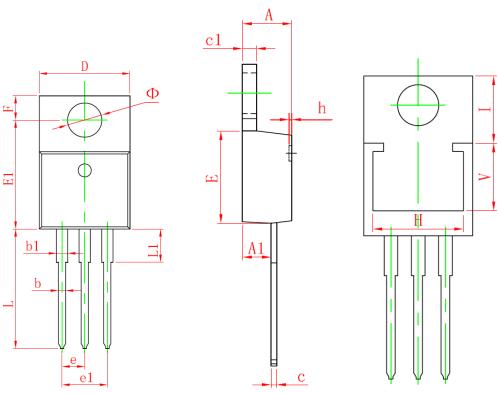


Figure 11 Normalized Maximum Transient Thermal Impedance

TO-220-3L Package Information



Crymh ol	Dimensions	In Millimeters	Dimensions In Inches			
Symbol	Min	Max	Min	Max		
A	4.470	4.670	0.176	0.184		
A1	2.520	2.820	0.099	0.111		
b	0.710	0.910	0.028	0.036		
b1	1.170	1.370	0.046	0.054		
c	0.330	0.650	0.013	0.026		
c1	1.200	1.400	0.047	0.055		
D	10.010	10.350	0.394	0.407		
E	8.500	8.900	0.335	0.350		
E1	12.060	12.460	0.475	0.491		
e	2.540	(TYP.)	0.100 (TYP.)		
e1	4.980	5.180	0.196	0.204		
F	2.590	2.890	0.102	0.114		
Н	8.44	0 REF.	0.332	REF.		
h	0.000	0.300	0.000	0.012		
L	13.400	13.800	0.528	0.543		
L1	3.560	3.960	0.140	0.156		
V	6.360 REF.		0.250 REF.			
I	6.300 REF.		0.248 REF.			
Ф	3.735	3.935	0.147	0.155		

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